



Graphene: A new Electronic Material

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Outline

- Introduction
- Results & Discussion
- Outlook
- Summary







Motivation: Moore's Law



Source: G.E. Moore, No exponential is forever..., ISSCC, February 2003



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Motivation: Moore's Law









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Electric Field Effect in Atomically Thin Carbon Films

K. S. Novoselov,¹ A. K. Geim,^{1*} S. V. Morozov,² D. Jiang,¹ Y. Zhang,¹ S. V. Dubonos,² I. V. Grigorieva,¹ A. A. Firsov²

Science, Oct. 2004

Ultrathin epitaxial graphite: 2D electron gas properties and a route toward graphene-based nanoelectronics.

Claire Berger,* Zhimin Song, Tianbo Li, Xuebin Li, Asmerom Y. Ogbazghi, Rui Feng, Zhenting Dai, Alexei N. Marchenkov, Edward H. Conrad, Phillip N. First, and Walt A. de Heer School of Physics, Georgia Institute of Technology, Atlanta, GA 30332-0430 (Dated: October 7, 2004)

J. Phys. Chem. B., 2004

 \rightarrow Route towards graphene layers







Graphene

Graphite



In plane: sp² bonded carbon atoms (~4,3eV)
Inter plane: weak v.d. Waals bonds (π-orbitals, ~0,07eV) Graphene



Monolayer of sp² bonded carbon atoms
Two-dimensional honeycomb lattice
Experimentally discovered by
A.K. Geim in 2004 and / or R. Ruoff in
1999

•Thought to be instable due to thermodynamic fluctuations \rightarrow recently solved (Meyer et al., Nature, 2007)





Graphene

Corrugated sheet of graphene (Meyer et al., Nature, 2007)





Peierls, Landau and Mermin happy as well !

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Fallen MESA of Graphite (Lu, Ruoff et al., Nanotechnology, 1999)





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Conduction in graphene vs. graphite

 π -orbitals responsible for carrier conduction in graphene







- -

Electronic properties of graphene

E-k diagram of graphene near K-point



Zero-gap semimetall

- Linear dispersion relation described by Fermi-Dirac instead of Schrödinger equation
- Massless dirac fermions, v ~ c/300
- μ > 25.000 cm²/Vs @ 300K
- J > 10⁸ A/cm²
- L_{MFP} ~ 400nm @ 300K

Potential for:

- High switching speeds
- **Ballistic devices**

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Device Fabrication / Manufacturing

- Thermal oxidation of silicon wafer
- Manual transfer of graphene layer from graphite (highly oriented pyrolitic graphite)
- Visual identification of single and few layer graphene











Characterization of graphene by AFM



- Step heights determined by AFM: 0.8-1.2 nm
- Measurements differ due to adsorbates
- → No reliable determination of layer thickness by AFM





Characterization of graphene by Raman spectroscopy









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- Optical lithography for contacts
- Evaporation of contact metals (Ti, Au, W...)













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A graphene Pseudo-FED



- N- and p-type conduction
- High off-current (=maximum resistivity)
- Minimum shifted from Vg = 0V
- → unintentional chemical doping

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π

All experimental data published until now obtained from graphene covered with SiO₂ on one side only.

- → Unrealistic situation since graphene devices for nanoelectronics would require passivation/packaging.
- π -orbitals responsible for electrical conduction in graphene SD²
- → What happens to mobility in case of graphene "sandwiched" in between dielectrics?



















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- Evaporation of contact metals (Ti, Au, W...) Electrical
- E-Beam gate lithography
- Evaporation of gate dielectric and metal





——— characterization

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Graphene FEDs with top gate



Graphene thickness by AFM: 1.5nm

- \rightarrow 1-3 layers
- \rightarrow Raman needed to identify exact number of layers

Lemme et al., IEEE EDL, April 2007

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Scanning Raman spectroscopy



- Confocal microscope setup
- λ = 633 nm
- Raman intensity increases from blue to yellow
- Ratio of Raman intensities at ~2640 and ~2670 cm⁻¹

Echtermeyer et al., tbp EPJ Graphene Week Dresden, 2007

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Transfer characteristics with and without top-gate



Unintentional chemical doping (I_{dmin} not @ V_{bg} = 0V)

Total current decreases (~ 1/5) for graphene "sandwiched" in SiO₂

Top-gate dielectric disturbs π-orbitals
Evaporated SiOx, no annealing (high Dit, Qox)

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Top gate transfer characteristics



- First demonstration of a top(!)-gated field effect device / transistor
- How about mobility?



Lemme et al., ULIS 2007 lemme@amo.de

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Mobility: a first approximation



Approximation of μ :

$$\mu = \sigma / (n^*q)$$

with

$$\sigma = J/E_{ds} = I/width * length/V_{ds}$$

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$$n = \epsilon * E_{eff}/q$$

- Mobility decreases (> 1/10) for graphene "sandwiched" in SiO₂ → dominant scattering mechanism seems to be substrate determined
- Yet higher values than universal mobility and especially higher than Ultra Thin Body SOI MOSFETs

Lemme et al., ULIS 2007

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"Engineering" graphene for electronics

Lateral Confinement

Chen et al., 2007



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Han et al., 2007







"Engineering" graphene for electronics

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New device architectures

Geim et. al., 2007



No further data published yet, but SET structure might impose on-current problems. ($I_{on} < 1nA$)

DPG Conference 2007, Regensburg, Germany

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Graphene vs. CNTs for electronics

Graphene	Carbon Nanotubes
2D graphene layers	Random placement
\rightarrow conventional lithography	
Band gap engineering by top down methods	Bottom up approach
No large scale technique today	Chirality problem

Graphene will remain a vibrant research playground as long as it can not be fabricated on large area.









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Summary

- Graphene is a promising option for future electronic materials
- Demonstration of the first top(!)-gated graphene field effect device
- Despite its semi-metal nature, a field effect can be observed
- Mobility in graphene is affected when a gate electrode is placed on top of the film
- Mobility clearly exceeds that of Silicon and especially UTB SOI
- Band gap engineering needed to further exploit properties









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